

(19) World Intellectual Property Organization  
International Bureau



(43) International Publication Date  
21 November 2002 (21.11.2002)

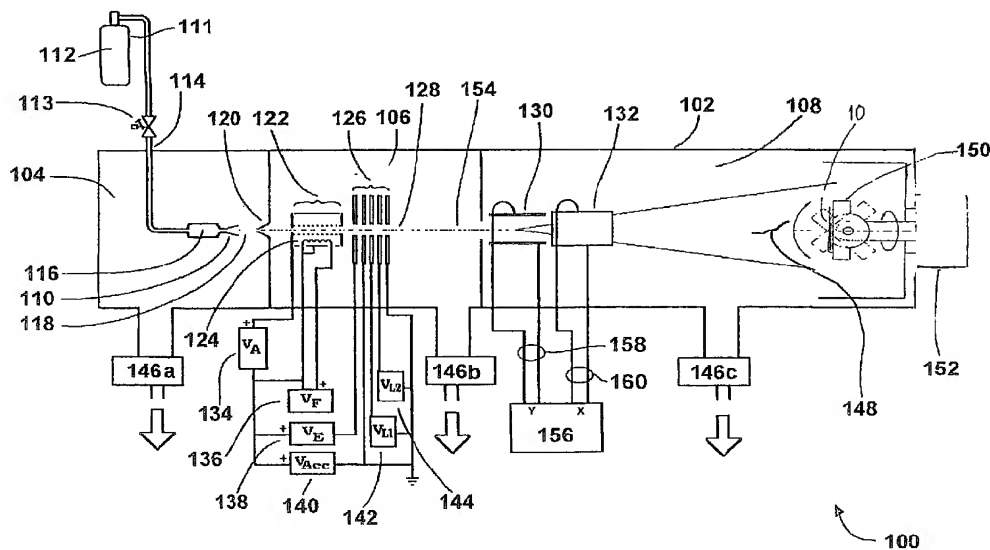
PCT

(10) International Publication Number  
**WO 02/093988 A1**

- (51) International Patent Classification<sup>7</sup>: **H05H 1/00**
- (21) International Application Number: PCT/US02/15236
- (22) International Filing Date: 13 May 2002 (13.05.2002)
- (25) Filing Language: English
- (26) Publication Language: English
- (30) Priority Data:  
60/290,389 11 May 2001 (11.05.2001) US  
60/317,652 6 September 2001 (06.09.2001) US
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- (81) Designated States (*national*): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, OM, PH, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TN, TR, TT, TZ, UA, UG, UZ, VN, YU, ZA, ZM, ZW.
- (84) Designated States (*regional*): ARIPO patent (GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- Published:**  
— with international search report

[Continued on next page]

(54) Title: METHOD AND SYSTEM FOR IMPROVING THE EFFECTIVENESS OF MEDICAL DEVICES BY ADHERING DRUGS TO THE SURFACE THEREOF



(57) Abstract: Medical devices (10) implanted or otherwise used in a mammal are made less prone to trigger adverse reactions by use of gas cluster ion-beam (GCIB) (128) surface modification and/or monometer ion beam surface modification to implant, apply, or adhere various drug molecules directly into or onto the surface of medical devices (10). This is accomplished without the need for a polymer or any other binding agent to retain the drug.



— *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments*

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## **METHOD AND SYSTEM FOR IMPROVING THE EFFECTIVENESS OF MEDICAL DEVICES BY ADHERING DRUGS TO THE SURFACE THEREOF**

### **CROSS REFERENCE TO RELATED APPLICATIONS**

5           This application claims priority of U. S. provisional application serial no. 60/290,389 entitled "Method and System for Improving the Effectiveness of Medical Devices by Applying/Adhering Drugs to their Surface in Combination with the Application of Ion Beam Technology", filed May 11, 2001, and U.S. provisional application serial no. 60/317,652 entitled "Method and System for Improving the Effectiveness of Medical  
10   Devices by Applying/Adhering Drugs to their Surface in Combination with the Application of Ion Beam Technology", filed September 6, 2001, both applications being incorporated herein by reference.

### **FIELD OF THE INVENTION**

          This invention relates generally to medical devices implantable in a mammal, such as  
15   coronary stents and to a method and system for applying and adhering drugs to the surface of medical devices using gas cluster ion beam technology and/or monomer ion beam technology. The invention can also be used with implantable prostheses.

### **BACKGROUND OF THE INVENTION**

          A coronary stent is an implantable medical device that is used in combination with  
20   balloon angioplasty. Balloon angioplasty is a procedure used to treat coronary atherosclerosis. Balloon angioplasty compresses built-up plaque against the walls of the blocked artery by the inflation of a balloon at the tip of a catheter inserted into the artery during the angioplasty procedure. Unfortunately, the body's response to this procedure

often includes thrombosis or blood clotting and the formation of scar tissue or other trauma-induced tissue reactions at the treatment site. Statistics show that restenosis or renarrowing of the artery by scar tissue after balloon angioplasty occurs in up to 35 percent of the treated patients within only six months after these procedures, leading to severe  
5 complications in many patients.

To reduce restenosis, cardiologists are now often placing a small metal tubular devices of various forms, such as wire mesh or expandable metal, called a coronary stent at the site of blockage during balloon angioplasty. The goal is to have the stent act as a scaffold to keep the coronary artery open after the removal of the balloon.

10 However, there are also serious complications associated with the use of coronary stents. Coronary restenotic complications associated with stents occur in 16 to 22 percent of all cases within six months after insertion of the stent and are believed to be caused by many factors acting alone or in combination. These complications could be reduced by several type of drugs introduced locally at the site of stent implantation. Because of the  
15 substantial financial costs associated with treating the complications of restenosis, such as catheterization, restenting, intensive care, etc., a reduction in restenosis rates would save money and reduce patient suffering.

Numerous studies suggest that the current popular designs of coronary stents are functionally equivalent and suffer a 16 to 22 percent rate of restenosis. Although the use of  
20 coronary stents is growing, the benefits of their use remain controversial in certain clinical situations or indications due to their potential complications. It is widely held that during the process of expanding the stent, damage occurs to the endothelial lining of the blood vessel triggering a healing response that re-occludes the artery. To help combat that

phenomenon, drug-coated stents are being introduced to the market to help control the abnormal cell growth associated with this healing response. These drugs are typically mixed with a liquid polymer and applied to the stent surface. When implanted, the drug elutes out of the polymer in time, releasing the medicine into the surrounding tissue. There remain a number of problems associated with this technology. Because the stent is expanded at the diseased site the polymeric material has a tendency to crack and sometimes delaminate from the stent surface. These polymer flakes can travel throughout the cardio-vascular system and cause significant damage. There is some evidence to suggest that the polymers themselves cause a toxic reaction in the body. Additionally, because of the thickness of the coating necessary to carry the required amount of medicine, the stents can become somewhat rigid making expansion difficult. In other prior art stents, the wire mesh of the stent itself is impregnated with one or more drugs through processes such as high pressure loading, spraying, and dipping. However, loading, spraying and dipping do not satisfactorily adhere the drug to the stent surface and therefore, in many instances, do not yield the optimal dosage of the drugs delivered to the surrounding tissue.

It is therefore an object of this invention to provide a means of applying and adhering drugs to medical devices using gas cluster ion beam technology and/or monomer ion beam technology.

It is a further object of this invention to apply drugs to medical stents by gas cluster ion beams and/or monomer ion beams to decrease the complication of restenosis and thrombosis.

## SUMMARY OF THE INVENTION

The objects set forth above as well as further and other objects and advantages of the present invention are achieved by the invention described hereinbelow.

The present invention is directed to the use of gas cluster ion-beam (GCIB) surface  
5 modification and/or monomer ion beam surface modification to implant, apply, or adhere various drug molecules directly into or onto the surface of a stent or other medical device thereby eliminating the need for a polymer or any other binding agent. This will prevent the problem of toxicity and the damage caused by transportation of delaminated polymeric material throughout the body. Further, unlike other prior art stents that load the stent  
10 material itself, the optimal dosage of the drug may be applied or adhered.

The application of the drug is achieved through the use of GCIB technology and/or monomer ion beam technology. The application of the drug is accomplished by several methods:

First a stent is processed using a GCIB and/or a monomer ion beam which will  
15 remove any contaminants and oxide layers from the surface rendering the surface electrically active and creating dangling bonds. The desired drug will then be introduced to the active surface and will bond with the dangling bonds.

A second method is to coat the stent surface with medicine in liquid form, impact the surface with energetic ion beam clusters and/or monomer ions implanting the drug  
20 molecules sub-surface in the form of a mechanical bond.

The third method is to electrostatically coat the stent surface with medicine in powder form and implant the drug molecules in the same manner described in the second method.

The application of drugs via gas cluster ion beam (GCIB) surface modification and/or monomer ion beam surface modification such as described above will reduce complications, lead to genuine cost savings and an improvement in patient quality of life, and overcome prior problems of thrombosis and restenosis.

5 For a better understanding of the present invention, together with other and further objects thereof, reference is made to the accompanying drawings and detailed description.

### BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a schematic view of a gas cluster ion beam processing system of the present invention;

10 Figure 2 is an exploded view of a portion of the gas cluster ion beam processing system showing the workpiece holder;

Figure 3 is an atomic force microscope image showing the surface of a coronary stent before GCIB processing;

15 Figure 4 is an atomic force microscope image showing the surface of a coronary stent after GCIB processing;

Figure 5 is a schematic view of a monomer ion beam processing system of the present invention;

Figure 6A is a graph showing the release rate of fluorescence over time; and

1 Figure 6B is a graph showing the cumulative release rate of fluorescence over time.

## DETAILED DESCRIPTION OF THE PREFERRED METHODS AND EMBODIMENTS

Beams of energetic ions, electrically charged atoms or molecules accelerated through high voltages under vacuum, are widely utilized to form semiconductor device junctions, to smooth surfaces by sputtering, and to enhance the properties of thin films. In the present invention, these same beams of energetic ions are utilized for the applying and adhering drugs to a surface of a medical device, such as a coronary stent.

In the preferred embodiment of the present invention, gas cluster ion beam (GCIB) processing is utilized. Gas cluster ions are formed from large numbers of weakly bound atoms or molecules sharing common electrical charges and accelerated together through high voltages to have high total energies. Cluster ions disintegrate upon impact and the total energy of the cluster is shared among the constituent atoms. Because of this energy sharing, the atoms are individually much less energetic than the case of conventional ions or ions not clustered together and, as a result, the atoms penetrate to much shorter depths. Surface sputtering effects are orders of magnitude stronger than corresponding effects produced by conventional ions, thereby making important microscale surface effects possible that are not possible in any other way.

The concept of GCIB processing has only emerged over the past decade. Using a GCIB for dry etching, cleaning, and smoothing of materials is known in the art and has been described, for example, by Deguchi, et al. in U.S. Patent No. 5,814,194, "Substrate Surface Treatment Method", 1998. Because ionized clusters containing on the order of thousands of gas atoms or molecules may be formed and accelerated to modest energies on the order of a few thousands of electron volts, individual atoms or molecules in the clusters may each



only have an average energy on the order of a few electron volts. It is known from the teachings of Yamada in, for example, U.S. Patent 5,459,326, that such individual atoms are not energetic enough to significantly penetrate a surface to cause the residual sub-surface damage typically associated with plasma polishing. Nevertheless, the clusters themselves  
5 are sufficiently energetic (some thousands of electron volts) to effectively etch, smooth, or clean hard surfaces.

Because the energies of individual atoms within a gas cluster ion are very small, typically a few eV, the atoms penetrate through only a few atomic layers, at most, of a target surface during impact. This shallow penetration of the impacting atoms means all of  
10 the energy carried by the entire cluster ion is consequently dissipated in an extremely small volume in the top surface layer during a period on the order of 10-12 seconds (i.e. one picosecond). This is different from the case of ion implantation which is normally done with conventional monomer ions and where the intent is to penetrate into the material, sometimes penetrating several thousand angstroms, to produce changes in the surface  
15 properties of the material. Because of the high total energy of the cluster ion and extremely small interaction volume, the deposited energy density at the impact site is far greater than in the case of bombardment by conventional monomer ions.

Reference is now made to Figure 1 of the drawings which shows the gas cluster ion beam (GCIB) processor 100 of this invention utilized for applying or adhering drugs to the  
20 surface of a coronary stent 10. Although not limited to the specific components described herein, the processor 100 is made up of a vacuum vessel 102 which is divided into three communicating chambers, a source chamber 104, an ionization/acceleration chamber 106, and a processing chamber 108 which includes therein a uniquely designed workpiece holder

150 capable of positioning the medical device for uniform GCIB bombardment and drug application by a gas cluster ion beam.

During the drug application method of this invention, the three chambers are evacuated to suitable operating pressures by vacuum pumping systems 146a, 146b, and 5 146c, respectively. A condensable source gas 112 (for example argon or N<sub>2</sub>) stored in a cylinder 111 is admitted under pressure through gas metering valve 113 and gas feed tube 114 into stagnation chamber 116 and is ejected into the substantially lower pressure vacuum through a properly shaped nozzle 110, resulting in a supersonic gas jet 118. Cooling, which results from the expansion in the jet, causes a portion of the gas jet 118 to 10 condense into clusters, each consisting of from several to several thousand weakly bound atoms or molecules. A gas skimmer aperture 120 partially separates the gas molecules that have not condensed into a cluster jet from the cluster jet so as to minimize pressure in the downstream regions where such higher pressures would be detrimental (e.g., ionizer 122, high voltage electrodes 126, and process chamber 108). Suitable condensable source gases 15 112 include, but are not necessarily limited to argon, nitrogen, carbon dioxide, oxygen.

After the supersonic gas jet 118 containing gas clusters has been formed, the clusters are ionized in an ionizer 122. The ionizer 122 is typically an electron impact ionizer that produces thermoelectrons from one or more incandescent filaments 124 and accelerates and directs the electrons causing them to collide with the gas clusters in the gas 20 jet 118, where the jet passes through the ionizer 122. The electron impact ejects electrons from the clusters, causing a portion the clusters to become positively ionized. A set of suitably biased high voltage electrodes 126 extracts the cluster ions from the ionizer 122, forming a beam, then accelerates the cluster ions to a desired energy (typically from 1 keV

to several tens of keV) and focuses them to form a GCIB 128 having an initial trajectory

154. Filament power supply 136 provides voltage  $V_F$  to heat the ionizer filament 124.

Anode power supply 134 provides voltage  $V_A$  to accelerate thermoelectrons emitted from filament 124 to cause them to bombard the cluster containing gas jet 118 to produce ions.

5 Extraction power supply 138 provides voltage  $V_E$  to bias a high voltage electrode to extract ions from the ionizing region of ionizer 122 and to form a GCIB 128. Accelerator power supply 140 provides voltage  $V_{Acc}$  to bias a high voltage electrode with respect to the ionizer 122 so as to result in a total GCIB acceleration energy equal to  $V_{Acc}$  electron volts (eV). One or more lens power supplies (142 and 144, for example) may be provided to  
10 bias high voltage electrodes with potentials ( $V_{L1}$  and  $V_{L2}$  for example) to focus the GCIB 128.

A medical device 10, such as a coronary stent, to be processed by the GCIB processor 100 is held on a workpiece holder 150, and disposed in the path of the GCIB 128 for irradiation. The present invention may be utilized with medical devices composed of a  
15 variety of materials, such as metal, polyethylene, ceramic, or combinations thereof. In order for the stent to be uniformly processed using GCIB, the workpiece holder 150 is designed in a manner set forth below to manipulate the stent 10 in a specific way.

Referring now to Figure 2 of the drawings, stent surfaces that are non-planar must remain oriented within a specific angle tolerance with respect to the normal beam incidence  
20 to obtain paramount effect to the stent surfaces utilizing GCIB. This requires a fixture or workpiece holder 150 with the ability to be fully articulated to orient all non-planar surfaces of stent 10 to be modified within that specific angle tolerance at a constant exposure level for process optimization and uniformity. Any stent 10 containing surfaces

that would be exposed to the process beam at angles of greater than +/- 15 degrees from normal incidence may require manipulation. More specifically, when applying GCIB to a coronary stent 10, the workpiece holder 150 is rotated and articulated by a mechanism 152 located at the end of the GCIB processor 100. The articulation/rotation mechanism 152  
5 preferably permits 360 degrees of device rotation about longitudinal axis 154 and sufficient device articulation about an axis 156 perpendicular to axis 154 to maintain the stent's surface to within +/- 15 degrees from normal beam incidence.

Under certain conditions, depending upon the size of the coronary stent 10, a scanning system may be desirable to produce uniform smoothness. Although not  
10 necessary for GCIB processing, two pairs of orthogonally oriented electrostatic scan plates 130 and 132 may be utilized to produce a raster or other scanning pattern over an extended processing area. When such beam scanning is performed, a scan generator 156 provides X-axis and Y-axis scanning signal voltages to the pairs of scan plates 130 and 132 through lead pairs 158 and 160 respectively. The scanning signal voltages are commonly triangular  
15 waves of different frequencies that cause the GCIB 128 to be converted into a scanned GCIB 148, which scans the entire surface of the stent 10.

When beam scanning over an extended region is not desired, processing is generally confined to a region that is defined by the diameter of the beam. The diameter of the beam at the stent's surface can be set by selecting the voltages ( $V_{L1}$  and/or  $V_{L2}$ ) of one or more  
20 lens power supplies (142 and 144 shown for example) to provide the desired beam diameter at the workpiece.

In one embodiment of the present invention, the surface of the medical device is irradiated with the gas cluster ion beam prior to the deposition of any drug on the surface

thereof. This will remove any contaminants and oxide layers from the stent surface rendering the surface electrically active and capable of attracting and bonding drug molecules that are then introduced to the surface. One or more types of drugs are deposited upon surface through vapor phase deposition or by introducing a liquid form of the drug onto the  
5 surface. In some instances, the liquid form of the drug is in solution with a volatile solvent thereby requiring the solvent to be evaporated. As the formed mechanical bonds are broken over time, the drug is slowly released to the site of stent implantation.

Studies have suggested that a wide variety of drugs may be useful at the site of contact between the medical device and the in vivo environment. For example, drugs such  
10 as anti-coagulants, anti-proliferics, antibiotics, immune-suppressing agents, vasodilators, anti-thrombotic substances, anti-platelet substances, and cholesterol reducing agents may reduce instances of restenosis when diffused into the blood vessel wall after insertion of the stent.

In yet another embodiment of the present invention, GCIB processing is utilized to impact the surface with energetic clusters thus implanting and forming a mechanical bond to  
15 the drug molecules of the medicine that had been applied in liquid form to coat the stent surface; or to implant the drug molecules of the electrostatically coated medicine in powder form to the stent surface in the same manner described above. The impact energy of the gas clusters results in a portion of the deposited drug molecules to form a carbon matrix at the surface. As the carbon matrix is formed, the remaining drug molecules become embedded  
20 within the interstices of the matrix. Over time, these drug molecules diffuse through the matrix and are released at the contact site between the stent and the blood vessel wall thereby continuously providing medication to the site.

As the atomic force microscope (AFM) images shown in Figures 3 and 4 demonstrate, it is possible to dramatically affect the surface on stents utilizing one embodiment of the present invention. Figure 3 shows a stent before GCIB treatment with gross surface micro-roughness on a strut edge. The surface roughness measured an  $R_a$  of 113 angstroms and an  $R_{RMS}$  of 148 angstroms. These irregularities highlight the surface condition at the cellular level where thrombosis begins. Figure 4 shows a stent after GCIB processing where the surface micro-roughness has been eliminated without any measurable physical or structural change to the integrity of the stent itself. The post-GCIB surface roughness measured an  $R_a$  of 19 angstroms and an  $R_{RMS}$  of 25 angstroms. In this manner, GCIB processing also provides the added benefit of smoothing the surface of the medical device while applying/adhering the drug to the surface. Non-smooth surfaces may snare fibrinogen, platelets, and other matter further promoting stenosis to occur.

In still another embodiment of the present invention, monomer ion beam implantation is be used with the present invention when significant penetration of the drug into the surface of the medical device is desired. Because of the high energies associated with the individual atoms, implantation at increased depths may be achieved. As can be seen in Figure 5, in a vacuum chamber 505, an ion source material 500, such as boron trifluoride for boron ions, is extracted from a plasma chamber 502 by electrostatic means, and focussed and accelerated to form an ion beam 507. A mass analysis device 501, such as a dipole sector magnet selects only the desired ion species, chosen to provide the desired chemical or physical effect upon implantation. The selected species is accelerated 503 to an energy chosen to give a very specific implant depth profile and irradiated into the surface of the stent 10 or other medical device held in place by the workpiece holder 150.

As described above for GCIB processing, one or more drugs are deposited upon a surface of the medical device and the medical device is positioned within the path of the monomer ion beam such that the surface having the drug deposited thereon will be irradiated during processing. More particularly, the workpiece holder described above is  
5 utilized due to the inherently non-planar design of the stent.

Now turning to Figures 6A and 6B, elution rates for a substance adhered to a surface of a coronary stent using GCIB processing in accordance with the present invention is shown. To demonstrate the release rate of a molecule adhered to the surface in accordance with the present invention, the surface was irradiated and a fluorescent organic  
10 dye was vapor deposited onto the freshly irradiated surface while the surface remained in the vacuum chamber. The dye elution rate was measured by observing the fluorescence of the elute as a function of time. In Figure 6A, the release rate is shown over time. In Figure 6B, the cumulative release rate is shown over time.

Although the invention has been described with respect to various embodiments, it  
15 should be realized this invention is also capable of a wide variety of further and other embodiments within the spirit and scope of the appended claims.

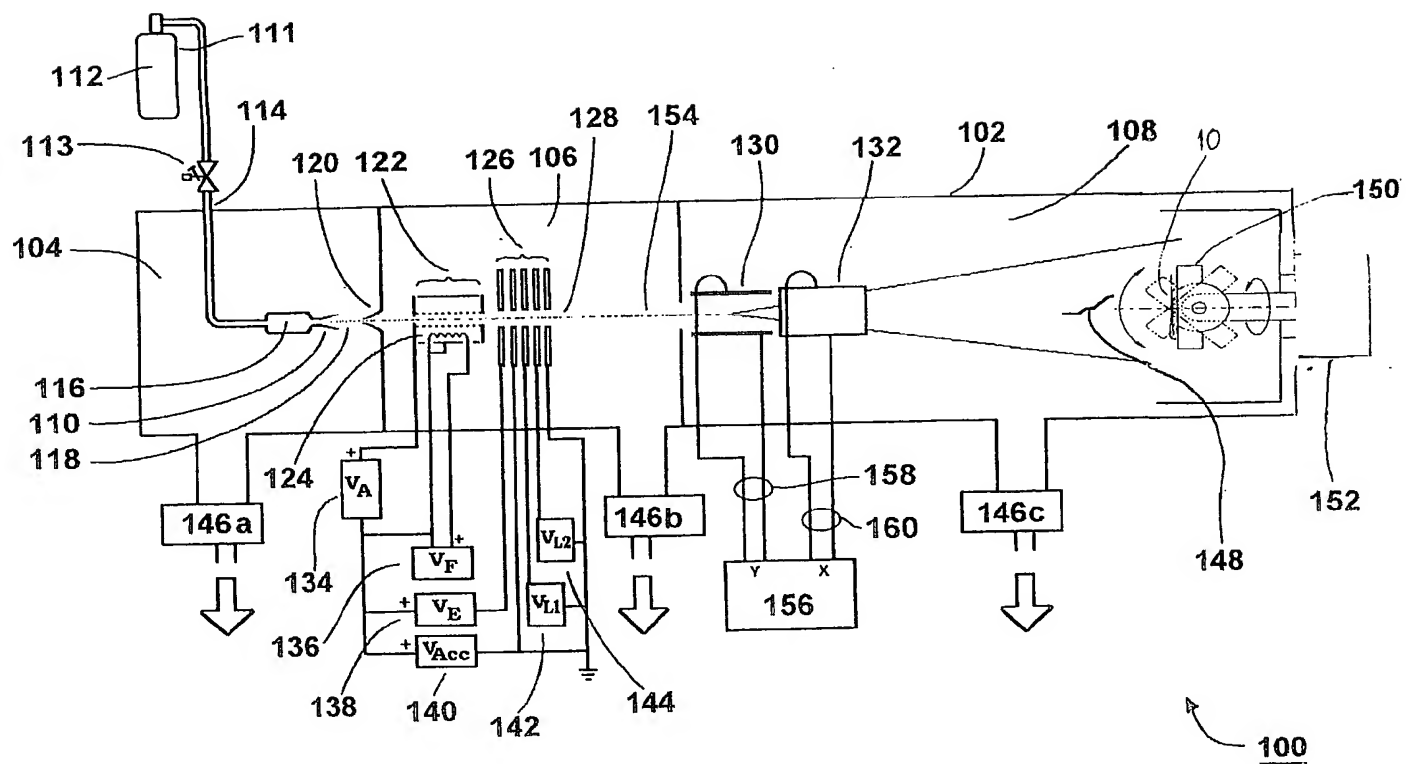
## CLAIMS

What is claimed is:

- 5 1. An apparatus for applying a drug to a surface of a medical device by ion beam processing comprising:
  - a vacuum chamber;
  - an ion beam source operably associated with the vacuum chamber for producing an
  - ion beam;
  - 10 positioning means for positioning the surface within the path of the ion beam; and
  - means for irradiating the surface with the ion beam such that a drug deposited thereon is irradiated by the ion beam.
- 15 2. A method for applying a drug to a surface of a medical device comprising the steps of:
  - depositing a drug onto a surface of the medical device;
  - forming an ion beam in a vacuum chamber;
  - positioning the surface of the medical device in the vacuum chamber for irradiation
  - by the ion beam; and
  - irradiating the deposited drug and the surface of the medical device with the ion
  - 20 beam.
3. The method of claim 2 wherein the depositing step is done by vapor phase deposition of the drug.
- 25 4. The method of claim 2 wherein the depositing step comprises introducing a liquid form of the drug into contact with the surface.
5. The method of claim 4 wherein the liquid form is a solution of the drug in a volatile solvent and further comprising the step of evaporating the volatile solvent.
- 30 6. The method of claim 2 wherein the drug is selected from the group consisting of anti-coagulants, antibiotics, immune-suppressing agents, vasodilators, anti-proliferics, anti-thrombotic substances, anti-platelet substances, cholesterol reducing agents and combinations thereof.
- 35 7. The method of claim 2 wherein the ion beam is a gas cluster ion beam.
8. The method of claim 2 wherein the ion beam is a monomer ion beam.
- 40 9. A method for applying a drug to a surface of a medical device comprising the steps of:
  - forming an ion beam in a vacuum chamber;
  - positioning the surface of the medical device in the vacuum chamber for irradiation
  - by the ion beam; and
  - irradiating the surface of the medical device with the ion beam; and
  - 45 depositing a drug onto a surface of the medical device.



10. A method of applying a drug to a surface of a medical device comprising the steps of:  
forming a first ion beam in a vacuum chamber;  
positioning the surface of the medical device in the vacuum chamber for irradiation  
5 by the first ion beam;  
irradiating the surface with the first ion beam;  
depositing a drug onto the surface;  
forming a second ion beam in a vacuum chamber;  
irradiating the surface and deposited drug with the second ion beam.
- 10 11. The method of claim 10 wherein the first and second ion beam comprise gas cluster ion beams.
12. The method of claim 10 wherein the first ion beam is a gas cluster ion beam and the  
15 second ion beam is a monomer ion beam.
13. The method of claim 10 wherein the medical device is a coronary stent.
14. The method of claim 10 wherein the drug is selected from the group consisting of anti-  
20 coagulants, antibiotics, immune-suppressing agents, vasodilators, anti-thrombotic substances, anti-platelet substances, cholesterol reducing agents and combinations thereof.
15. A drug delivery system comprising a medical device having at least one irradiated surface, said irradiated surface having a carbon matrix layer formed during irradiation and a  
25 drug embedded within the interstices of the carbon matrix, such drug being embedded concurrently with the formation of the carbon matrix layer.
16. A method of producing a drug delivery system comprising the steps of:  
depositing a drug on a surface of a medical device; and  
30 irradiating the surface such that a carbon matrix layer is formed during irradiation and the drug is concurrently embedded within the interstices of the carbon matrix.
17. A medical device with an anti-reaction drug at its surface as made by the method of  
35 claim 1.
18. A medical device with an anti-reaction drug at its surface as made by the method of  
claim 2.
19. A medical device with an anti-reaction drug at its surface as made by the method of  
40 claim 9.
20. A medical device with an anti-reaction drug at its surface as made by the method of  
claim 10.



**Figure 1**

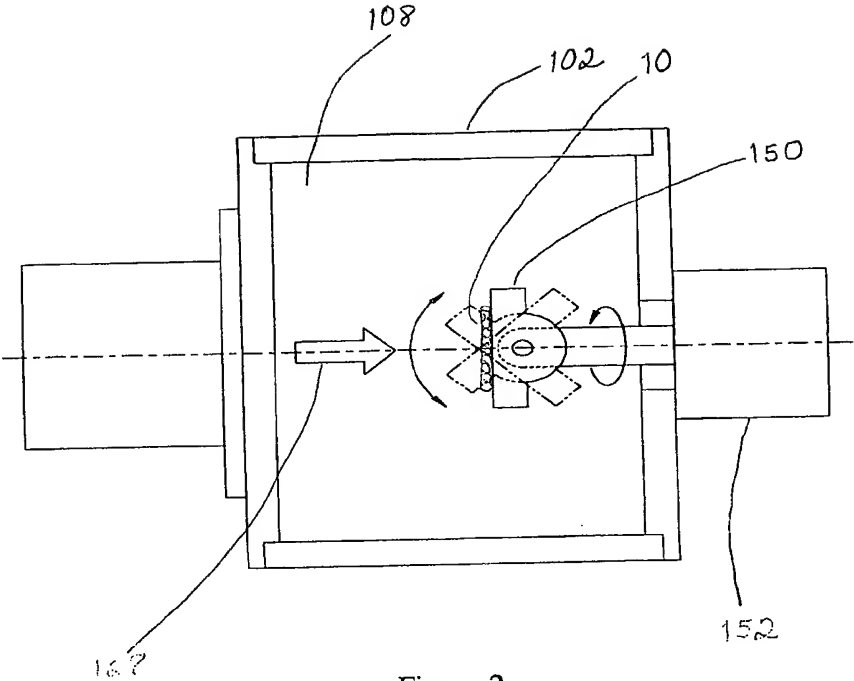


Figure 2

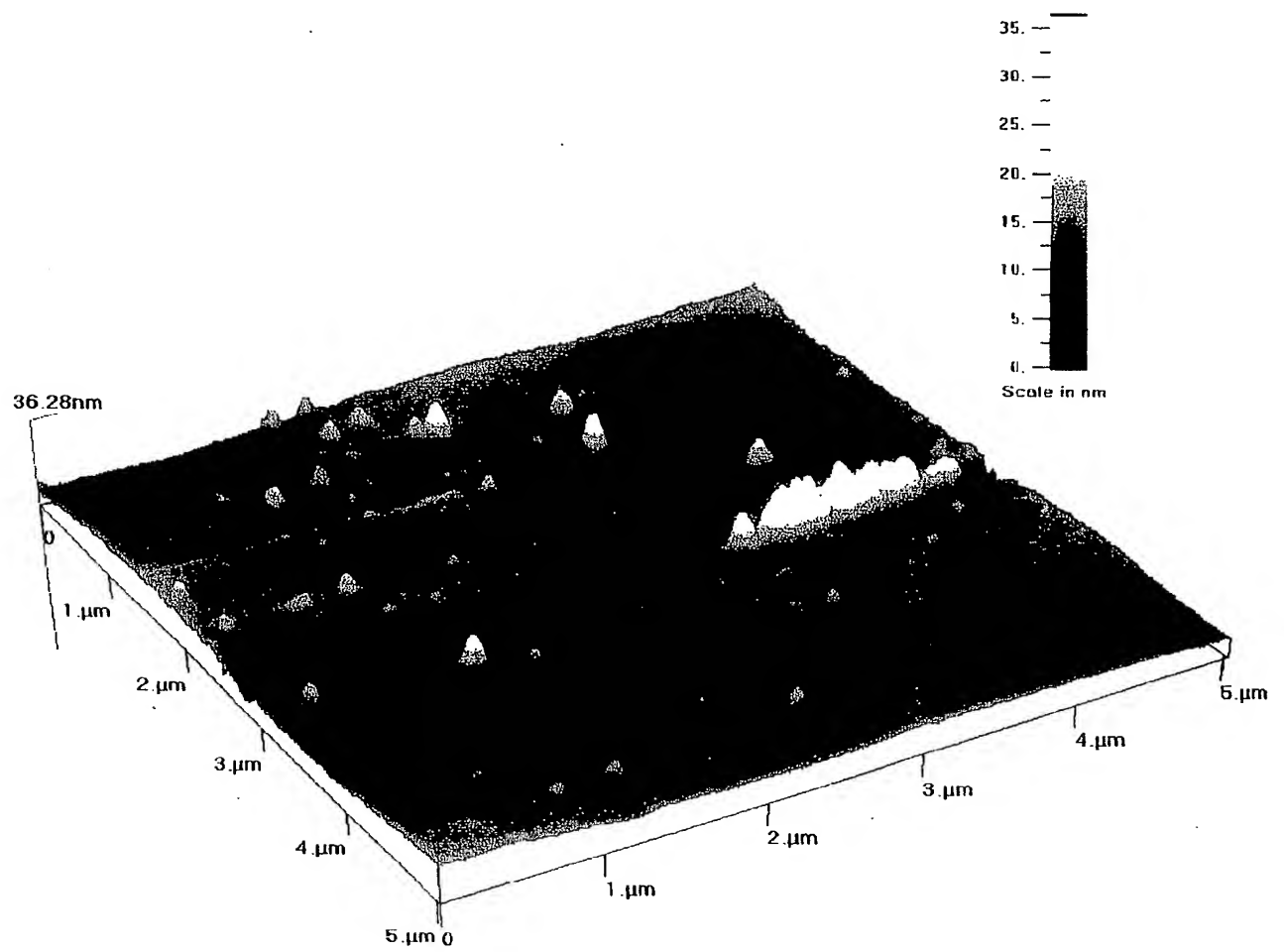


Figure 3

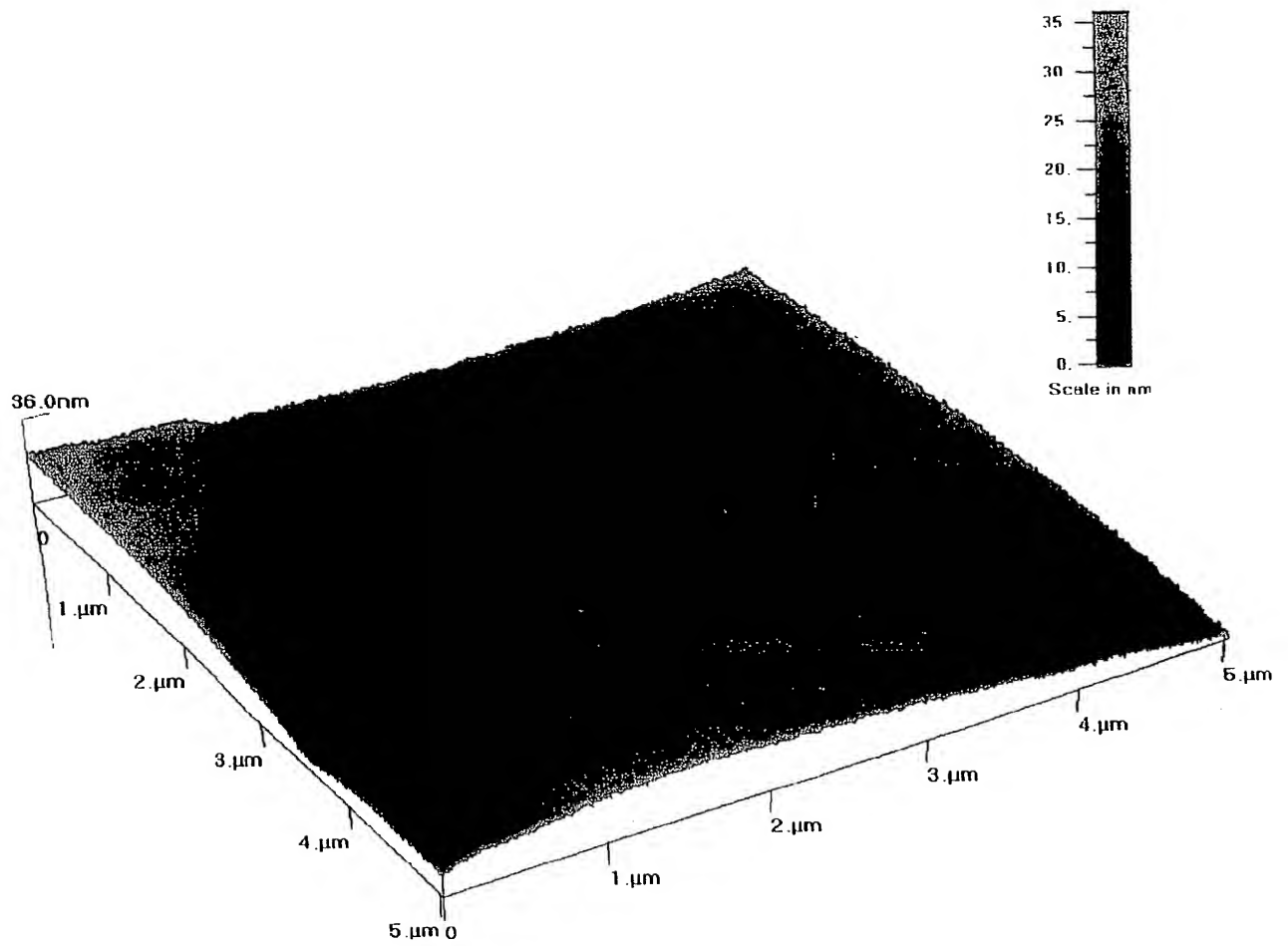


Figure 4

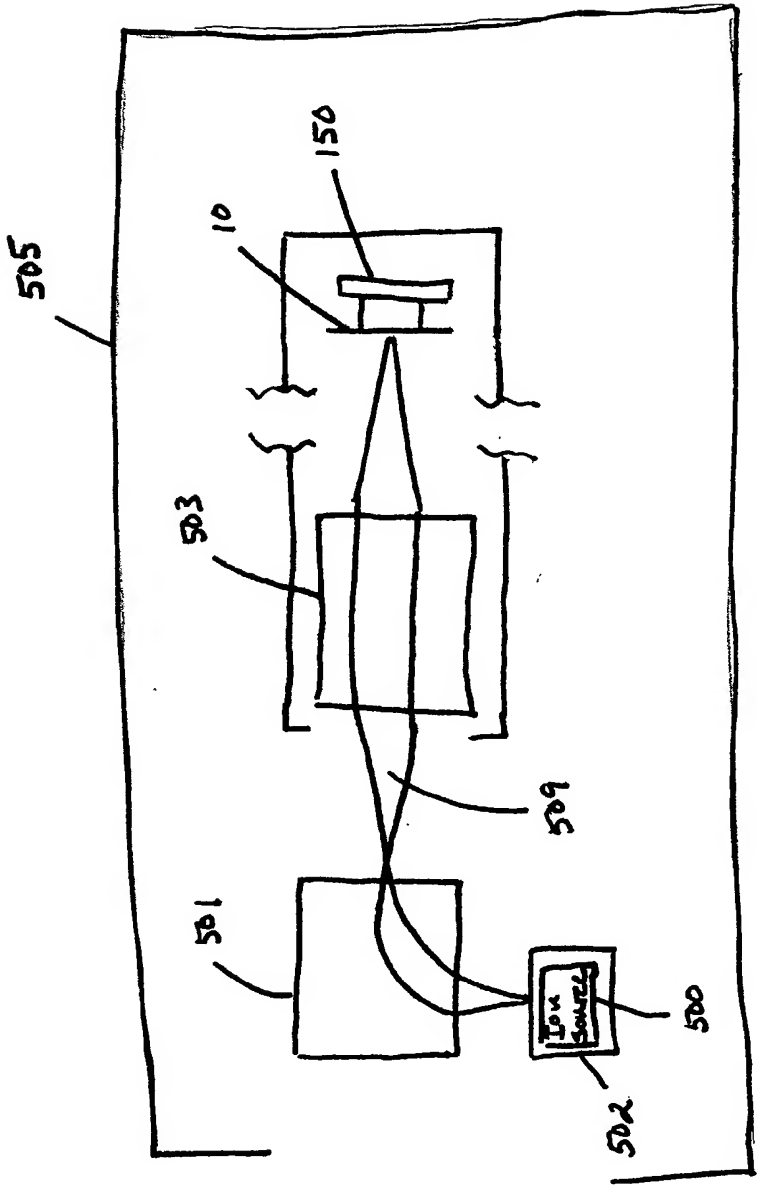


Figure 5

# Release Rate

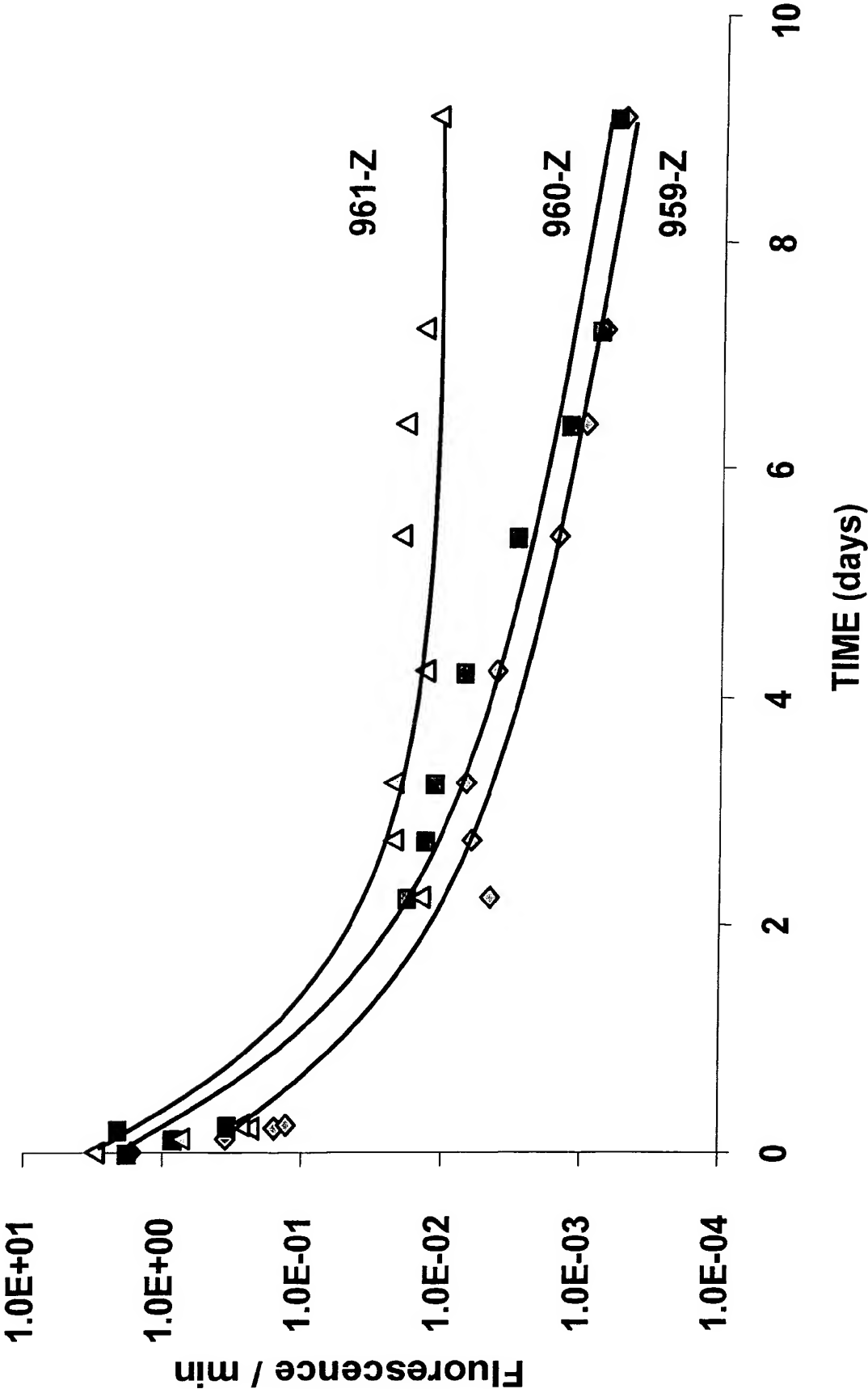


FIGURE 6A

Cumulative release

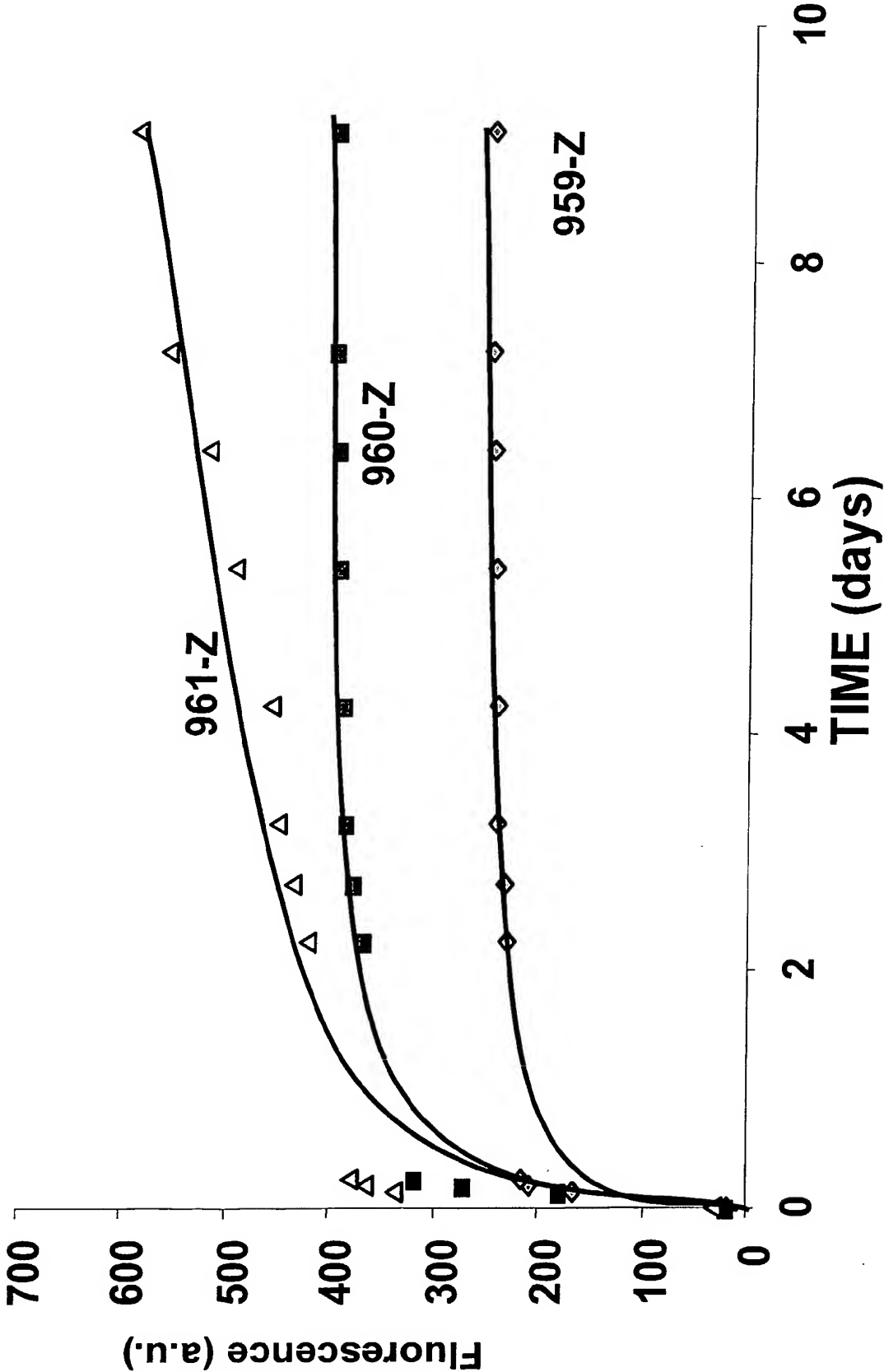


FIGURE 6B



# INTERNATIONAL SEARCH REPORT

International application No.

PCT/US02/15236

<b>A. CLASSIFICATION OF SUBJECT MATTER</b>				
IPC(7) : H05H 1/00				
US CL : 313/359.1, 362.1, 161				
According to International Patent Classification (IPC) or to both national classification and IPC				
<b>B. FIELDS SEARCHED</b>				
Minimum documentation searched (classification system followed by classification symbols) U.S. : 313/359.1, 362.1, 161				
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched				
Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)				
<b>C. DOCUMENTS CONSIDERED TO BE RELEVANT</b>				
Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.		
A	US 5,123,924 A (Sioshansi et al.) 23 June 1992 (23.06.1992), Abstract and Col. 2, lines 31-49.	1-20		
A	US 6,331,227 B1 (Dykstra et al.) 18 December 2001 (18.12.2001), Abstract, and Col. 4, line 64 to Col. 5, line 17.	7, 8, 11, and 12		
<input type="checkbox"/> Further documents are listed in the continuation of Box C. <input type="checkbox"/> See patent family annex.				
<table border="0"> <tr> <td> <p>* Special categories of cited documents:</p> <p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier application or patent published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p> </td> <td> <p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone</p> <p>"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art</p> <p>"&amp;" document member of the same patent family</p> </td> </tr> </table>			<p>* Special categories of cited documents:</p> <p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier application or patent published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p>	<p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone</p> <p>"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art</p> <p>"&amp;" document member of the same patent family</p>
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Date of the actual completion of the international search		Date of mailing of the international search report		
24 July 2002 (24.07.2002)		29 OCT 2002		
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